SLLS111B - SEPTEMBER 1980 - REVISED MAY 1995

10**U**T

3 20UT

- Meets or Exceeds the Requirements of ANSI Standards EIA/TIA-422-B and EIA/TIA-423-B and ITU Recommendations V.10 and V.11
- Operates From Single 5-V Power Supply
- Wide Common-Mode Voltage Range
- High Input Impedance
- TTL-Compatible Outputs
- High-Speed Schottky Circuitry
- 8-Pin Dual-in-Line and Small-Outline Packages
- Designed to Be Interchangeable With National DS9637A

# V<sub>CC</sub> [ 1 8 ] 1IN+ 1OUT [ 2 7 ] 1IN-2OUT [ 3 6 ] 2IN+ GND [ 4 5 ] 2IN-

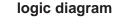
uA9637AC...D OR P PACKAGE (TOP VIEW)

#### description

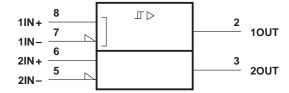
The uA9637AC is a dual differential line receiver designed to meet ANSI Standards EIA/TIA-422-B and EIA/TIA-423-B and ITU Recommendations V.10 and V.11. The line receiver utilizes Schottky circuitry and has TTL-compatible outputs. The inputs are compatible with either a single-ended or a differential-line system. This device operates from a single 5-V power supply and is supplied in an 8-pin dual-in-line package or small-outline package.

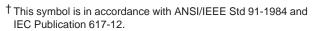
The uA9637AC is characterized for operation from 0°C to 70°C.

#### logic symbol<sup>†</sup>



2IN+







Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

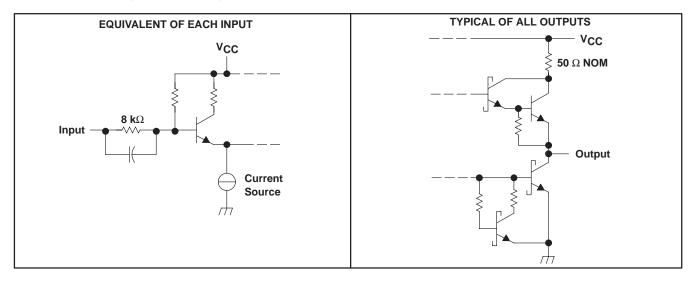
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#### schematics of inputs and outputs



#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

Supply voltage range, V <sub>CC</sub> (see Note 1)	
Differential input voltage, V <sub>ID</sub> (see Note 2)	
Output voltage range, V <sub>O</sub> (see Note 1)	
Low-level output current, I <sub>OL</sub>	50 mA
Continuous total dissipation	See Dissipation Rating Table
Operating free-air temperature range, T <sub>A</sub>	0°C to 70°C
Storage temperature range, T <sub>stg</sub>	–65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	260°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. All voltage values, except differential input voltage, are with respect to the network ground terminal.
  - 2. Differential input voltage is measured at the noninverting input with respect to the corresponding inverting input.

#### DISSIPATION RATING TABLE

PACKAGE	T <sub>A</sub> ≤ 25°C POWER RATING	OPERATING FACTOR ABOVE T <sub>A</sub> = 25°C	T <sub>A</sub> = 70°C POWER RATING	T <sub>A</sub> = 125°C POWER RATING
D	725 mW	5.8 mW/°C	464 mW	—
Р	1000 mW	8.0 mW/°C	640 mW	—



#### recommended operating conditions

	MIN	NOM	MAX	UNIT
Supply voltage, V <sub>CC</sub>	4.75	5	5.25	V
Common-mode input voltage, V <sub>IC</sub>			±7	V
Operating free-air temperature, TA	0		70	°C

# electrical characteristics over recommended ranges of supply voltage, common-mode input voltage, and operating free-air temperature (unless otherwise noted)

PARAMETER		TEST CO	TEST CONDITIONS			MAX	UNIT
\/ı <del>_</del>	Positive-going input threshold voltage See Note 3					0.2	V
VIT+						0.4	v
VIT – Negative-going input threshold voltage		Can Nata D					
		See Note 3	See Note 3				V
V <sub>hys</sub>	Hysteresis voltage (V <sub>IT+</sub> -V <sub>IT-</sub> )				70		mV
VOH	High-level output voltage	V <sub>ID</sub> = 0.2 V,	$I_{O} = -1 \text{ mA}$	2.5	3.5		V
VOL	Low-level output voltage	$V_{ID} = -0.2 V,$	l <sub>O</sub> = 20 mA		0.35	0.5	V
1.	l land summer t	$V_{CC} = 0$ to 5.5 V,	V <sub>I</sub> = 10 V		1.1	3.25	mA
1	Input current	See Note 4	$V_{I} = -10 V$		-1.6	-3.25	mA
IOS	Short-circuit output current§	$V_{O} = 0,$	$V_{ID} = 0.2 V$	-40	-75	-100	mA
ICC	Supply current	V <sub>ID</sub> = -0.5 V,	No load		35	50	mA

<sup>†</sup> All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ .

<sup>‡</sup> The algebraic convention, in which the less positive (more negative) limit is designated as minimum, is used in this data sheet for threshold levels only.

§ Only one output should be shorted at a time, and duration of the short circuit should not exceed one second.

NOTES: 3. The expanded threshold parameter is tested with a 500- $\Omega$  resistor in series with each input.

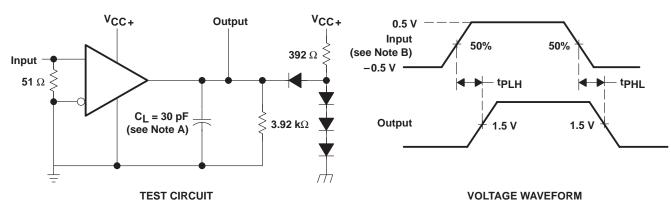
4. The input not under test is grounded.

## switching characteristics, V\_{CC} = 5 V, T<sub>A</sub> = 25°C

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
<sup>t</sup> PLH	Propagation delay time, low- to high-level output	$C_1 = 20$ pE Soo Eiguro 1		15	25	ns
<sup>t</sup> PHL	Propagation delay time, high- to low-level output	$C_{L} = 30 \text{ pF}$ , See Figure 1		13	25	ns



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### PARAMETER MEASUREMENT INFORMATION

NOTES: A. CL includes probe and jig capacitance.

B. The input pulse is supplied by a generator having the following characteristics:  $t_f \le 5$  ns,  $t_f \le 5$  ns, PRR  $\le 5$  MHz, duty cycle = 50%.

Figure 1. Test Circuit and Voltage Waveform

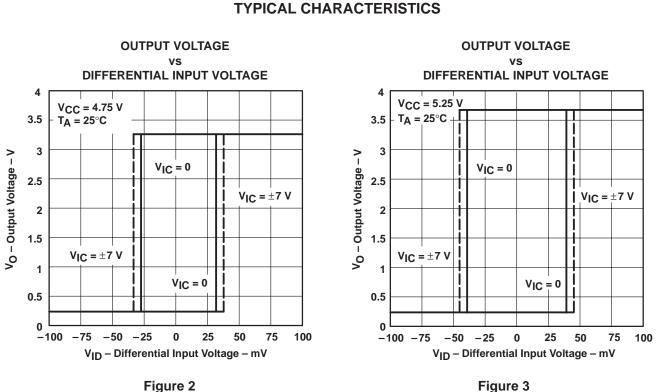
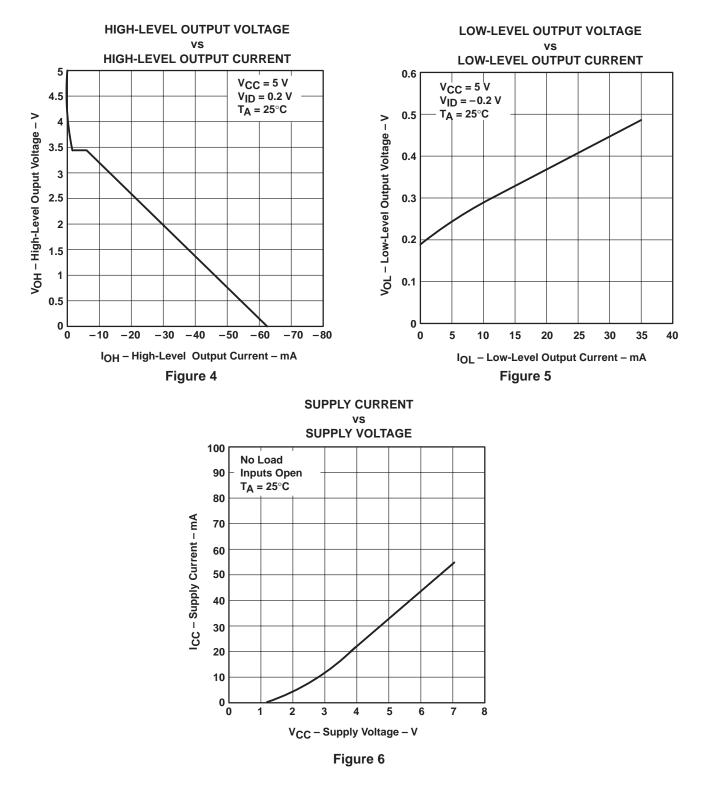


Figure 3



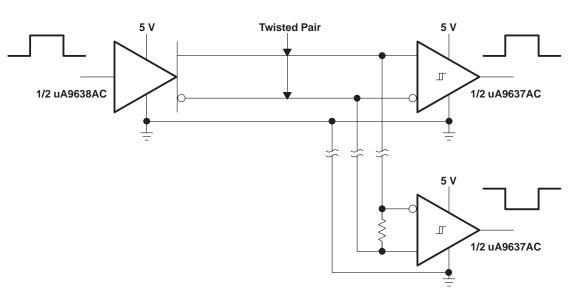
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#### **TYPICAL CHARACTERISTICS**



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**APPLICATION INFORMATION** 

## Figure 7. EIA/TIA-422-B System Applications



#### PACKAGING INFORMATION

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
UA9637ACD	ACTIVE	SOIC	D	8	75	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR
UA9637ACDR	ACTIVE	SOIC	D	8	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR
UA9637ACJG	OBSOLETE	CDIP	JG	8		None	Call TI	Call TI
UA9637ACP	ACTIVE	PDIP	Р	8	50	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
UA9637ACPSR	ACTIVE	SO	PS	8	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR Level-1-235C-UNLIM

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - May not be currently available - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

None: Not yet available Lead (Pb-Free).

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean "Pb-Free" and in addition, uses package materials that do not contain halogens, including bromine (Br) or antimony (Sb) above 0.1% of total product weight.

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDECindustry standard classifications, and peak solder temperature.

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## **MECHANICAL DATA**

MCER001A - JANUARY 1995 - REVISED JANUARY 1997



#### **CERAMIC DUAL-IN-LINE**



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification.
- E. Falls within MIL STD 1835 GDIP1-T8



## **MECHANICAL DATA**

MPDI001A - JANUARY 1995 - REVISED JUNE 1999



- NOTES: A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. Falls within JEDEC MS-001

For the latest package information, go to http://www.ti.com/sc/docs/package/pkg\_info.htm



D (R-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).

D. Falls within JEDEC MS-012 variation AA.



### **MECHANICAL DATA**

## PS (R-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE



A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



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